

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Akihiko Ishibashi</td> <td>10/13/2006</td> </tr> <tr> <td>Toshiya Yokogawa</td> <td>10/10/2006</td> </tr> <tr> <td>Toshitaka Shimamoto</td> <td>10/13/2006</td> </tr> <tr> <td>Yoshiaki Hasegawa</td> <td>10/13/2006</td> </tr> <tr> <td>Yasutoshi Kawaguchi</td> <td>10/13/2006</td> </tr> <tr> <td>Isao Kidoguchi</td> <td>10/13/2006</td> </tr> </tbody> </table>		Name	Execution Date	Akihiko Ishibashi	10/13/2006	Toshiya Yokogawa	10/10/2006	Toshitaka Shimamoto	10/13/2006	Yoshiaki Hasegawa	10/13/2006	Yasutoshi Kawaguchi	10/13/2006	Isao Kidoguchi	10/13/2006
Name	Execution Date														
Akihiko Ishibashi	10/13/2006														
Toshiya Yokogawa	10/10/2006														
Toshitaka Shimamoto	10/13/2006														
Yoshiaki Hasegawa	10/13/2006														
Yasutoshi Kawaguchi	10/13/2006														
Isao Kidoguchi	10/13/2006														
RECEIVING PARTY DATA															
Name:	Matsushita Electric Industrial Co., Ltd.														
Street Address:	1006 Oaza Kadoma, Kadoma-shi														
City:	Osaka														
State/Country:	JAPAN														
Postal Code:	571-8501														
PROPERTY NUMBERS Total: 1															
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11568336</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11568336										
Property Type	Number														
Application Number:	11568336														
CORRESPONDENCE DATA															
Fax Number:	(202)912-0774														
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
Phone:	2029123800														
Email:	ppc@us.panasonic.com														
Correspondent Name:	Kenji Kamata														
Address Line 1:	1130 Connecticut Ave., N.W., Suite 1100														
Address Line 2:	Panasonic Patent Center														
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20036														
NAME OF SUBMITTER:	Kenji Kamata														

CH \$40.00 11568336

Total Attachments: 2

source=Assignment 11568336(P38851-01 Renner)#page1.tif

source=Assignment 11568336(P38851-01 Renner)#page2.tif

Matsushita Ref*: P038851-01
 Japan Firm Name: Okuda & Associates
 US Firm Name*: ROB
 (* must be filled)

Application Serial No. 11/568,336
 Japan Firm Ref: A5043MT-US1
 US Firm Ref: _____

ASSIGNMENT

WHEREAS, the undersigned has (have) invented the invention entitled:

Box 1		
Title of Invention: NITRIDE SEMICONDUCTOR DEVICE AND PROCESS FOR PRODUCING THE SAME		
1. For use when signing Declaration prior to filing U.S. patent application (check only one box below)		
(a) <input type="checkbox"/> for which an application for U.S. patent has been executed by the undersigned concurrently herewith, or		
(b) <input type="checkbox"/> for which an application for U.S. patent has been executed on the following date(s): _____, or <small>(if Declaration & Assignment are signed on the same day, check (a) and make no entry in the blank; if the Declaration was signed before this Assignment, enter the date(s) on which you signed the Declaration)</small>		
(c) <input checked="" type="checkbox"/> for which an International Application has been filed as: <small>(for the PCT-US national entry, check only (c) and enter PCT application number in the right)</small>	PCT Application No.	PCT/JP2005/007525 and,
2. For use when signing Declaration after filing U.S. patent application		
(d) <input type="checkbox"/> for which an application for U.S. patent has been filed on:	Application Filing Date	and,

WHEREAS, Matsushita Electric Industrial Co., Ltd. of 1006. Oaza Kadoma, Kadoma-shi, Osaka 571-8501, JAPAN, and

its/their heirs, successors, legal representatives and assigns (hereinafter designated as "Assignee(s)") is/are desirous of acquiring the entire right, title, and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged and intended to be legally bound hereby, the undersigned, by these presents, does sell, assign and transfer unto said Assignee(s) the entire and exclusive right, title and interest in and to: (i) said invention in the United States of America, its territories, dependencies and possessions (hereinafter designated as the United States) and in all countries foreign to the United States; and (ii) this patent application and any and all related patent application(s) disclosing said invention, including provisionals, non-provisionals, conversions, divisions, continuations, continuations-in-part and reissues thereof in the United States and all countries foreign to the United States (hereinafter designated as "Related Applications"), along with all rights of priority created by this patent application under any treaty relating thereto; and (iii) any and all Letters Patent(s), including all renewals, extensions, reissues and reexamination certificates which may be granted therefore, and all rights to sue for past and future infringement thereunder, in the United States and in all countries foreign to the United States for the full term or terms thereof.

The undersigned agree(s) to execute all papers necessary in connection with this application and any and all Related Applications thereof, all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements, all papers necessary in connection with any interference which may be declared concerning this application or any and all Related Applications thereof and to cooperate with the Assignee(s) in every way possible in obtaining and producing evidence and proceeding with such interference, and for any and all litigations regarding, or for the purpose of protecting the right, title and interest in and to said invention, this application and any and all Related Applications or Letters Patent(s) therefore, and to testify in any legal proceeding relating thereto and in support thereof, for the benefit of Assignee(s), and also to execute separate assignments in connection with such applications as the Assignee(s) may deem necessary or expedient.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States and any foreign patent(s) to the Assignee(s) and to vest all rights hereby conveyed to the Assignee(s) as fully and entirely as the same would have been held by the undersigned if this Assignment had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents, and officials of all foreign countries, whose duty is to issue patents, to issue any and all Letters Patent(s) resulting from said application or any and all Related Applications thereof to said Assignee(s) and hereby covenants that the undersigned has (have) full right to convey the entire interest herein assigned, and that the undersigned has (have) not executed, and will not execute, any assignment, sale, agreement or encumbrances in conflict herewith.

The undersigned hereby does sell, assign and transfer unto said Assignee(s) the full and exclusive authority for revoking power of attorney(s) executed by the undersigned in connection with this application and for appointing a new power of attorney in place thereof. The undersigned hereby grant(s) the Assignee(s) and the appointed U.S. patent attorneys and agents the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent Office for recordation of this document.

The undersigned hereby agree(s) that the above obligations shall apply to the undersigned both individually and collectively.

The undersigned hereby agree(s) that this Assignment shall be construed in accordance with the law of the appropriate jurisdiction within the United States.

IN WITNESS WHEREOF, executed by the undersigned on the date(s) following the undersigned name(s) and signature(s).

Box2 (Each Inventor, please Sign and Date below)			
	(e) First Name, Last Name	(f) Signature	(g) Date signed
(1)	Akihiko Ishibashi	<i>Akihiko Ishibashi</i>	Oct 13, 2006
(2)	Toshiya Yokogawa	<i>Toshiya Yokogawa</i>	Oct. 10, 2006
(3)	Toshitaka Shimamoto	<i>Toshitaka Shimamoto</i>	Oct. 13, 2006
(4)	Yoshiaki Hasegawa	<i>Yoshiaki Hasegawa</i>	Oct. 13, 2006

Check if additional paper(s) is/are attached. Total of 2 pages are submitted.

ASSIGNMENT (Cont.)

Additional Inventors:

Box2 (Continued)			
	(e) First Name, Last Name	(f) Signature	(g) Date signed
(5)	Yasutoshi Kawaguchi	<i>Yasutoshi Kawaguchi</i>	Oct. 13, 2006
(6)	Isao Kidoguchi	<i>Isao Kidoguchi</i>	Oct. 13, 2006
(7)			
(8)			
(9)			
(10)			
(11)			
(12)			
(13)			
(14)			
(15)			
(16)			
(17)			
(18)			
(19)			
(20)			
(21)			
(22)			

Check if additional paper(s) is/are attached. Total of 2 pages are submitted.